

## Screencleaner – ready-to-use

**SYS-CLEAN® SCC1.0** is a solvent-based cleaning medium for cleaning SMT print stencils and screens with water-soluble emulsions.

**SYS-CLEAN® SCC1.0** reliably cleans solder pastes and SMT adhesives, as well as thick film pastes or conductive adhesives from stencils and screens in explosion-proof systems. Due to its high flash point, it can also be used in screen printers and automatic machines.



### Application

Pollution	Suitability
Lead-containing fluxes	✓ ✓
Lead free fluxes	✓ ✓
Water soluble fluxes	✓ ✓
Solder pastes	✓ ✓
Oils/fats	✓

### Application parameters

Parameter	
Application temperature	20°C
Cleaning duration approx.	5-8 min.
Rinsing	SCC1.0
Drying	Compressed air
Application Concentration	ready-to-use

✓ ✓ = Excellent    ✓ = Optimal    ○ = Optional    ✗ = Not recommended

### Specifications

SYS-CLEAN® SCC1.0 ready-to-use

pH-Value	n. A.
Density (at 20°C)	0,891 g/cm³
Initial boiling point and boiling range	N. V.
Flashpoint	>45 °C

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Application		
Spray-in-air		✓ ✓
Immersion cleaning air agitated		✓ ✓
Spray under Immersion		✓ ✓
Ultrasonic		✓ ✓
Manual cleaning		✓

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### Advantages:

**SYS-CLEAN® SCC1.0** can be used without any problems in ex-protected spray cleaning systems without external explosion protection due to its high flash point. An additional filtration additionally extends the very good bath life.

**SYS-CLEAN® SCC1.0** can be dried very well and the short cleaning time helps to optimize the process duration.

### Storage:

Store well closed containers in a cool and dry place. Store away from heat and ignition sources.

### Availability:

**SYS-CLEAN® SCC2.0 Concentrate** is available in the following sizes

Item number: 64903518 – 25L

Item number : 64903519 – 200L



The product is free of questionable ingredients according to the SIN- & SVHC-Lists



100% compliant with EU guidelines RoHS 1 & 2, WEEE